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Parameter	Value	Unit
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$V_{CES, min} @ 25\text{ °C } 1$

Absolute Maximum Ratings at $T_{vj}=25$ unless otherwise noted

Parameter	Symbol	Value	Unit
Collector emitter voltage	V_{CES}	650	V
Gate emitter voltage	V_{GES}	± 20	V
Transient gate emitter voltage, $T_P \quad \mu s, D < 0.01$		± 30	V
Continuous collector current ¹⁾ , $T_C = 25 \text{ }^\circ C$	I_C	30	A
Continuous collector current ¹⁾ , $T_C = 100 \text{ }^\circ C$		15	A
Pulsed collector current ²⁾ , $T_C = 25 \text{ }^\circ C$	$I_{C, pulse}$	45	A
Diode forward current ¹⁾ , $T_C = 25 \text{ }^\circ C$	I_F	30	A
Diode forward current ¹⁾ , $T_C = 100 \text{ }^\circ C$		15	A
Diode pulsed current ²⁾ , $T_C = 25 \text{ }^\circ C$	$I_{F, pulse}$	45	A
Power dissipation ³⁾ , $T_C = 25 \text{ }^\circ C$	P_D	250	W
Operation and storage temperature	T_{stg}, T_{vj}	-55 to 175	$^\circ C$
Short circuit withstand time $V_{GE} = 15 \text{ V}, V_{CC} = 400 \text{ V}$ Allowed number of short circuits < 1000 Time between short circuits: 1.0 S $T_{vj} = 150 \text{ }^\circ C$	tsc	10	s

Thermal Characteristics

Parameter	Symbol	Value	Unit
IGBT thermal resistance, junction-case	R	0.6	$^\circ C/W$
Diode thermal resistance, junction-case	R	2.0	$^\circ C/W$
Thermal resistance, junction-ambient ⁴⁾	R	75	$^\circ C/W$

Electrical Characteristics at $T_{vj}=25$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Collector-emitter breakdown voltage	$V_{(BR)CES}$	650			V	$V_{GE}=0$ V, $I_C=0.5$ mA
Collector-emitter saturation voltage	$V_{CE(sat)}$		1.65	2.0	V	$V_{GE}=15$ V, $I_C=15$ A, $T_{vj}=25$ °C
			1.8		V	$V_{GE}=15$ V, $I_C=15$ A, $T_{vj}=125$ °C
			1.9			$V_{GE}=15$ V, $I_C=15$ A, $T_{vj}=175$ °C
Gate-emitter threshold voltage	$V_{GE(th)}$	4.4	5.2	6.0	V	$V_{CE}=V_{GE}$, $I_D=0.5$ mA
Diode forward voltage	V_F		1.65	2.0	V	$V_{GE}=0$ V, $I_F=15$ A, $T_{vj}=25$ °C
			1.8			$V_{GE}=0$ V, $I_F=15$ A, $T_{vj}=125$ °C
			1.9			$V_{GE}=0$ V, $I_F=15$ A, $T_{vj}=175$ °C
Gate-emitter leakage current	I_{GES}			100	nA	$V_{CE}=0$ V, $V_{GE}=20$ V
Zero gate voltage collector current	I_{CES}			10		$V_{CE}=650$ V, $V_{GE}=0$ V

OST15N65PRF

Enhancement Mode N-Channel Power IGBT



Typ.	Max.	Unit	Test condition	TDI	EMC / P A
2015		pF	$V_{GE}=0\text{ V},$ $V_{CE}=25\text{ V},$		

Electrical Characteristics Diagrams

<p>Figure 1. Typical output characteristics ($T_j=25\text{ }^\circ\text{C}$)</p>	<p>Figure 2. Typical output characteristics ($T_j=150\text{ }^\circ\text{C}$)</p>
<p>Figure 3. Typical transfer characteristics ($V_{CE}=20\text{ V}$)</p>	<p>Figure 4. Typical capacitance ($V_{GE}=0\text{V}$, $f=100\text{ kHz}$)</p>
<p>Figure 5. Typical gate charge</p>	<p>Figure 6. Gate-emitter threshold voltage</p>

46810121416051015202530354045IC, Collector current (A)

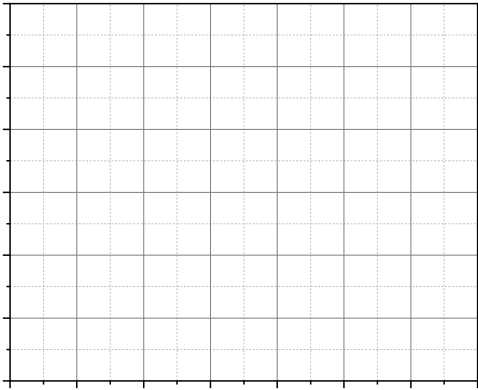


Figure 7. Typical collector-emitter voltage

Figure 8. Forward characteristic of diode

Figure 9. IGBT transient thermal impedance

Figure 10. Diode transient thermal impedance

Package Information

Symbol	mm		
	Min	Nom	Max
A	4.40	4.50	4.60
A1	1.27	1.30	1.33
A2	2.30	2.40	2.50
b	0.70	-	0.90
b1	1.27	-	1.40
c	0.45	0.50	0.60
D	15.30	15.70	16.10
D1	9.10	9.20	9.30
D2	13.10	-	13.70

Ordering Information

Package Type Unit
063.4 7